



3D Printing of MEMS Technology, Volume II

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Message from the Guest Editor

3D printing is currently an emerging technology. While it was mostly used for rapid prototyping previously, this technology has long entered rapid production, especially for complicated objects or small lot sizes. Most recently, new 3D printing technologies have emerged that enable the smallest features, at the micro- or even nano-scale, to be printed. At the same time, well-known problems, such as the waviness of fused deposition modeling (FDM) printed parts, the missing long-term stability of some typical printing materials, or the reduced mechanical properties of 3D-printed objects, still exist. The first Special Issue focussing on 3D printing of MEMS technology contains studies on various 3D printing techniques, underlining the possibilities provided by recent technologies. We now welcome the most recent developments in this interdisciplinary research area for the second volume.





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